



Cheng-Ta Chiang (S'00-M'05-SM'13) was born in Taiwan, R.O.C., in 1977. He received the B.S. degree in electronics engineering from Chung Yuan Christian University, Jhongli, Taiwan, in 1999, the M.S. degree in biomedical engineering from the National Cheng Kung University, Tainan, Taiwan, in 2001, and the Ph.D. degree in electronics engineering from the National Chiao Tung University, Hsinchu, Taiwan, in 2006. He was a Visiting Scholar with the Department of Electrical and Computer Engineering, The Johns Hopkins University, Baltimore, MD, from October 1, 2004 until November 30, 2005. Since 2007, he was a review committee member of the National Chip Implementation Center, Hsinchu. From 2006 to 2010, he was a Member of Technical Staff at Industrial Technology Research Institute, Hsinchu, and was responsible for Nyquist & Oversampled A/D converters, and MEMS circuits. Since 2010, he was with National Chia Yi University, Chiayi, Taiwan, and now serviced as Professor in the Department of Electrical Engineering. From 2015, he is a Consultant of Chiayi County Government, Taiwan. He is simultaneously the first and corresponding author of more than 110 of technical papers in IEEE international journals and conferences. He also holds several patents, including an U.S. patent. His main research interests include analog integrated circuits, biomedical electronics, image sensor circuits and systems, sensor signal conditioning and transducers, Nyquist A/D converters, and high-resolution DT and CT delta-sigma modulator.

Dr. Chiang is a IEEE conference reviewer servicing for I² MTC 2008, 2015-2019, Sensors 2018, BioCAS 2019, 2021, and 2023, ISCAS 2020, and a journal reviewer for IEEE JOURNAL OF SOLID-STATE CIRCUITS, IEEE TRANSACTIONS ON CIRCUITS AND SYSTEMS I: REGULAR PAPERS, IEEE TRANSACTIONS ON CIRCUITS AND SYSTEMS II: EXPRESS BRIEFS, IEEE TRANSACTIONS ON INSTRUMENTATION AND MEASUREMENT, IEEE PHOTONICS JOURNAL, IEEE TRANSACTIONS ON VERY LARGE SCALE INTEGRATION (VLSI) SYSTEMS, IEEE TRANSACTIONS ON INDUSTRIAL ELECTRONICS, IEEE SENSORS JOURNAL, Sensors and Actuators A: Physical, Sensors, IET Circuits, Devices & Systems,

IET The Journal of Engineering , Microelectronics Journal, EURASIP Journal on Advanced in Signal Processing, International Journal of Electronics, Circuits, Systems & Signal Processing, Mechatronics, Measurement Science and Technology, Micromachines, Applied Sciences, Food Chemistry, International Journal of Circuit Theory and Applications, Journal of Aquatic Food Product Technology, and an editorial advisory board member for the SENSORS & TRANSDUCERS JOURNAL. In 2017-2020, he is a secretary of IEEE Solid-State Circuits (SSC) Society Tainan Chapter, Taiwan. Since 2017, he is an Associate Editor serviced for IEEE SENSORS JOURNAL and awarded Best Performance Associate Editor Award for 2018 and 2019, respectively. Since 2018, he is an Associate Editor serviced for IEEE INTERNET OF THINGS JOURNAL. Since 2019, he is a Topical Editor serviced for IEEE SENSORS JOURNAL. Since 2023, he is an Associate Editor serviced for IEEE *Transactions on AgriFood* Electronics. Since 2021, he is a member of IEEE CAS Society Sensory Systems Technical Committee (SSTC). In 2022, he is a review committee member of 2022, 2023, 2024, and 2025 IEEE International Symposium on Circuits and Systems (IEEE ISCAS 2022, 2023, 2024, and 2025). He was a recipient of the 2017 Distinguished Teaching Award (School level) and 2021 Distinguished Teaching Award (College level) in National Chia Yi University, Taiwan. He was a recipient of IEEE Sensors Journal Best Performance Topical Editor Award for 2021, 2022, and 2024. In 2023 to 2024, he was the chair of IEEE CASS Tainan Chapter. The IEEE CASS Tainan Chapter he led was gloriously awarded as 2024 IEEE CASS Regional Chapter-of-the-Year Award: Region 10 award. In 2023, he was a recipient of Best Design of TSRI Outstanding Chip Design Award, Taiwan.